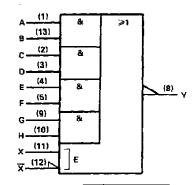
- Package Options Include Plastic and Ceramic DIPs and Ceramic Flat Packages
- Dependable Texas Instruments Quality and Reliability

description

These devices are expandable 4-wide AND-OR-INVERT gates. They perform the Boolean function $Y = \overline{AB + CD + EF + GH + X}$ with X = output of SN5460/SN7460.

The SN5453 is characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to 125 °C. The SN7453 is characterized for operation from 0 °C to 70 °C.

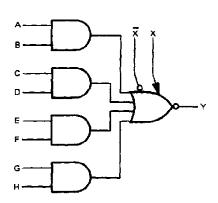
logic symbol[†]

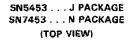


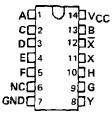
positive logic: $Y = \overline{AB + CD + EF + GH + X}$ X = output of SN5460/SN7460

Pin numbers shown are for J and N packages.

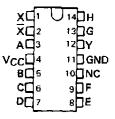
logic diagram (positive logic)



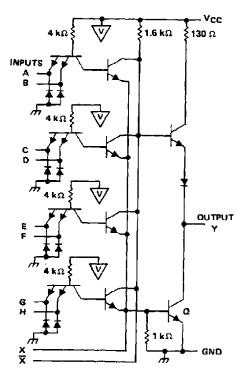




SN5453 ... W PACKAGE (TOP VIEW)



schematic



Resistor values shown are nominal. If expander is not used, leave X and \overline{X} open.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



 $^{^\}dagger \text{This}$ symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

SN5453, SN7453 **EXPANDABLE 4-WIDE AND OR INVERT GATES**

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Operating free-air temperature range: SN5453..... -55°C to 125°C Storage temperature range -65 °C to 150 °C

NOTE 1: Voltage values are with respect to network ground terminals.

recommended operating conditions

			SN5453			SN7453		
		MIN	MOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	v
VIH	High-level input voltage	2			2			v
VIL	Low-level input voltage			8,0			0.8	V
ЮН	High-level output current			- 0.4			- 0.4	mA
loL	Low-level output current			16			16	mA
TA	Operating free-air temperature	– 5 5		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]			SN5453 .			SN7453			
FARAMETER				MIN	TYP#	MAX	MIN	TYP#	MAX	UNIT
VIK	V _{CC} = MIN.	l = _ 12 mA				- 1.5			- 1.5	V
∨он	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = - 0.4 mA	2.4	3.4		2,4	3.4		V
VOL	V _{CC} = MIN,	V _{!H} = 2 V,	I _{OL} = 16 mA		0.2	0.4		0.2	0.4	V
L _L	V _{CC} = MAX,	V ₁ = 5.5 V			_	1			1	mA
ŢŢĦ	V _{CC} = MAX.	V _{IH} ≈ 2.4 V	_			40			40	μΑ
łIL	V _{CC} = MAX,	V _{IL} = 0.4 V				- 1.6			1.6	mA
los§	V _{CC} = MAX			- 20		- 55	- 18		- 55	mΑ
ICCH	VCC = MAX,	V + = 0 V			4	8		4	8	mA
CCL	V _{CC} = MAX,	See Note 2			5.1	9.5		5.1	9.5	mΑ
I ⊼ ₹	V _{XX} = 0.4 V,	IOL = 16 mA				- 2.9			- 3.1	mΑ
V	$I_X+I_{\overline{X}}=0.41 \text{ mA}$	$H\overline{\chi}\chi = 0$,	I _{OL} = 16 mA			1.1				V
VBE(Q)¶	lχ+l⊽ = 0.62 mA,	Fiχχ = 0,	IOL = 16 mA						1	v
v _{OH} 1	$I_X = 0.15 \text{ mA},$	$i\overline{\chi} = -0.15 \mathrm{mA}$	IOH = - 0.4 mA	2.4	3.4					>
YOH'	Ix = 0.27 mA,	$i\overline{\chi} = -0.27 \text{mA}$,	I _{OH} = - 0.4 mA		-		2.4	3.4		·
V _{OL} 1	IX+IX = 0.3 mA,	$R\overline{\chi}_X = 138 \Omega$,	IOL = 16 mA		0.2	0.4				>
VOL'	$I_X+I_X^- = 0.43 \text{ mA},$	$R\overline{\chi}_X = 130 \Omega$,	IOL = 16 mA					0.2	0.4	Y

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS			TYP	MAX	UNIT
[†] PLH	Any	Y	$R_1 = 400 \Omega_c$	C ₁ = 15 pF #		13	22	ns
tPHL	- C''I	,	11 400 st; Of 13 pt		8	15	ns	

[#] Expander pins open.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at VCC = 5 V, TA = 25 °C.

[§] Not more than one output should be shorted at a time.

 $[\]P$ Using expander inputs, VCC = MIN, TA = MIN, except typical values. NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

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